

# XM2 – ESMexpress® COM with Intel® Core™ 2 Duo

- Intel® Core™ 2 Duo up to 2.26 GHz
- Up to 4 GB DDR3 SDRAM
- 1 x16 PCI Express® Graphics link
- 4 x1 PCI Express® links
- 2 Gb Ethernet
- 3 SATA ports
- 8 USB 2.0
- Up to 2 SDVO ports
- Intel® HD audio
- 0°C to +85°C Tcase screened
- Conduction cooling



The XM2 is a Computer-On-Module which together with an application-specific carrier board forms a semi-custom solution for industrial, harsh, mobile and mission-critical environments.

The XM2 is controlled by a Intel® Core™ 2 Duo CPU with a clock frequency of up to 2.26 GHz and a total power consumption of up to 40W.

The XM2 can accommodate 4 GB of DDR3 DRAM memory and supports other memory like USB Flash on the carrier board.

The GS45 graphics controller supports x16 PCI Express® Graphics or up to two SDVO interfaces or DisplayPort® (3 ports) or 2 HDMI ports.

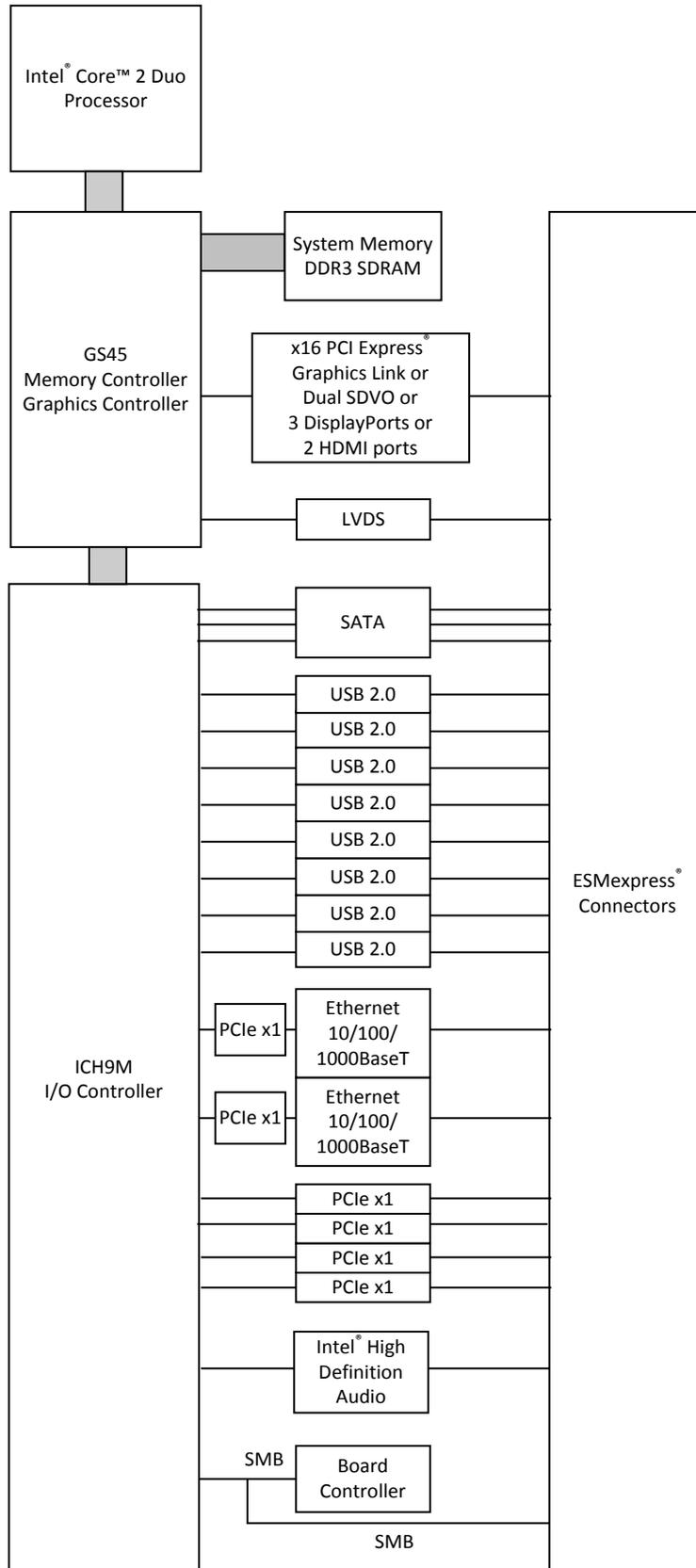
In addition, four x1 or one x4 PCI Express® links are supported by the XM2. Other modern serial interfaces are 2 Gigabit Ethernet channels, 8 USB ports, 3 SATA ports, and one HD audio port. These interfaces are all routed from the XM2 for availability on any ESMexpress® carrier board.

The XM2 is completed by a board management controller for temperature and power supervision. It comes with an InsydeH2O™ EFI BIOS configurable for the final application.

The XM2 is screened for operation from 0°C to +85°C (Tcase). As all ESMexpress® modules it is embedded in a covered frame. This ensures EMC protection and allows efficient **conductive cooling**. Air cooling is also possible by applying a heat sink on top of the cover. With a low power processor the module may even be operated in an extended temperature range. ESMexpress® modules are firmly screwed to a carrier board and come with rugged industry-proven connectors supporting high frequency and differential signals. Only soldered components are used to withstand shock and vibration, and the design is optimized for conformal coating. All ESMexpress® modules support a single 95x125mm form factor.

For evaluation and development purposes an ATX carrier board is available. The ESMexpress® module can be evaluated on a COM Express™ carrier board via an adapter from ESMexpress® to COM Express™.

# Diagram



## Technical Data

<b>CPU</b>	<ul style="list-style-type: none"> <li>■ Intel® Core™ 2 Duo SP9300 <ul style="list-style-type: none"> <li>□ Up to 2.26GHz processor core frequency</li> <li>□ 800/1066MHz system bus frequency</li> </ul> </li> <li>■ Chipset <ul style="list-style-type: none"> <li>□ Northbridge: Intel® GS45</li> <li>□ Southbridge: Intel® ICH9M-E</li> </ul> </li> </ul>
<b>Memory</b>	<ul style="list-style-type: none"> <li>■ Up to 6MB L2 cache integrated in Core 2 Duo</li> <li>■ Up to 4GB DDR3 SDRAM system memory <ul style="list-style-type: none"> <li>□ Soldered</li> <li>□ 800/1067MHz memory bus frequency locked to the FSB frequency</li> </ul> </li> </ul>
<b>Serial ATA (SATA)</b>	<ul style="list-style-type: none"> <li>■ Three ports via ESMexpress® connector</li> <li>■ Transfer rates up to 3Gbit/s (SATA 3.0)</li> </ul>
<b>Graphics</b>	<ul style="list-style-type: none"> <li>■ Integrated in Intel® GS45 chipset</li> <li>■ Maximum resolution: 2048 × 1536 pixels (QXGA)</li> <li>■ One x16 link (PCI Express® graphics) or</li> <li>■ Up to two SDVO ports</li> <li>■ One LVDS port (4 bit, max. 1366x768)</li> <li>■ Available via ESMexpress® connector</li> </ul>
<b>USB</b>	<ul style="list-style-type: none"> <li>■ Eight USB 2.0 host ports</li> <li>■ UHCI implementation</li> <li>■ Data rates up to 480Mbit/s</li> <li>■ Available via ESMexpress® connector</li> </ul>
<b>Ethernet</b>	<ul style="list-style-type: none"> <li>■ Two 10/100/1000Base-T Ethernet channels</li> <li>■ Ethernet controllers connected by two x1 PCIe® links</li> <li>■ Two LED signals per channel for LAN link, activity status and connection speed</li> <li>■ Available via ESMexpress® connector</li> </ul>
<b>PCI Express®</b>	<ul style="list-style-type: none"> <li>■ Two x1 links to connect local 1000Base-T Ethernet controllers</li> <li>■ Four x1 links or one x4 link via ESMexpress® connector (switchable on the carrier)</li> <li>■ Data rate 250MB/s in each direction (2.5 Gbit/s per lane)</li> </ul>
<b>GPIO</b>	<ul style="list-style-type: none"> <li>■ 1 line from PIC via ESMexpress® connector</li> <li>■ Usable for LED</li> </ul>
<b>HD audio</b>	<ul style="list-style-type: none"> <li>■ Via ESMexpress® connector</li> </ul>
<b>Board Management Controller</b>	<ul style="list-style-type: none"> <li>■ Input voltage supervision</li> <li>■ Power sequencing</li> <li>■ Board monitoring</li> <li>■ Watchdog</li> <li>■ Accessible via SMBus</li> </ul>
<b>Miscellaneous</b>	<ul style="list-style-type: none"> <li>■ Real-time clock (with GoldCap or battery backup on the carrier board)</li> <li>■ SMBus interface</li> </ul>
<b>Electrical Specifications</b>	<ul style="list-style-type: none"> <li>■ Supply voltage/power consumption: <ul style="list-style-type: none"> <li>□ +12V (-25%/+33%), power consumption up to 40W</li> <li>□ +5V (-5%/+5%) standby voltage</li> </ul> </li> </ul>
<b>Mechanical Specifications</b>	<ul style="list-style-type: none"> <li>■ Dimensions: 95mm x 125mm</li> <li>■ ESMexpress® PCB mounted between a frame and a cover</li> <li>■ Weight: 230g (incl. cover and frame)</li> </ul>

## Technical Data

<b>Environmental Specifications</b>	<ul style="list-style-type: none"><li>■ Temperature range (operation): 0..+85°C Tcase (ESMexpress® cover/frame) (screened)</li><li>■ Temperature range (storage): -40..+85°C</li><li>■ Relative humidity (operation): max. 95% non-condensing</li><li>■ Relative humidity (storage): max. 95% non-condensing</li><li>■ Altitude: -300m to + 3,000m</li><li>■ Shock: 15g/11ms (EN 60068-2-27)</li><li>■ Bump: 10g/16ms (EN 60068-2-29)</li><li>■ Vibration (sinusoidal): 1g/10..150Hz (EN 60068-2-6)</li><li>■ Conformal coating on request</li></ul>
<b>MTBF</b>	<ul style="list-style-type: none"><li>■ 154,077h @ 40°C according to IEC/TR 62380 (RDF 2000)</li></ul>
<b>Safety</b>	<ul style="list-style-type: none"><li>■ PCB manufactured with a flammability rating of 94V-0 by UL recognized manufacturers</li></ul>
<b>EMC</b>	<ul style="list-style-type: none"><li>■ EMC behavior depends on the system and housing surrounding the ESMexpress® module. MEN has performed general, successful EMC tests for ESMexpress® using the XC1 evaluation carrier according to EN 55022 (radio disturbance), IEC 61000-4-2 (ESD), IEC 61000-4-3 (electromagnetic field immunity), IEC 61000-4-4 (burst), IEC 61000-4-5 (surge) and IEC 61000-4-6 (conducted disturbances)</li></ul>
<b>BIOS</b>	<ul style="list-style-type: none"><li>■ InsydeH2O™ UEFI Framework</li></ul>
<b>Software Support</b>	<ul style="list-style-type: none"><li>■ Windows® (Windows® XP, Windows® 7)</li><li>■ Linux<ul style="list-style-type: none"><li>□ tested/verified with: Ubuntu 10.04 (kernel 2.6.32-21) 32-bit and 64-bit versions</li><li>□ OpenSuse 11.3 32-bit and 64-bit versions</li><li>□ and: CentOS 5.5 (kernel 2.6.18) 32-bit and 64-bit versions</li><li>□ <a href="#">Detailed matrix of supported interfaces under Ubuntu 10.04 and OpenSuse 11.3</a></li></ul></li><li>■ VxWorks® (in preparation)</li><li>■ QNX®</li><li>■ <a href="#">For more information on supported operating system versions and drivers see Downloads.</a></li></ul>

## Configuration & Options

### Standard Configurations

Article No.	CPU Type	Clock	System RAM	Temperature	Cover
15XM02-00	SP9300	2.26 GHz	2 GB	0..+85°C Tcase	yes
15XM02-01	Celeron M 722	1.2 GHz	2 GB	0..+85°C Tcase	yes

### Options

#### CPU

- Intel® SP9300, 2.26GHz, 1066MHz FSB, 6MB cache, 25W
- Intel® SL9400, 1.86GHz, 1066MHz FSB, 6MB cache, 17W
- Intel® SU9300, 1.2GHz, 800MHz FSB, 3MB cache, 10W
- Intel® Celeron® M722, 1.2GHz, 800MHz FSB, 1MB cache, 5.5W
- Intel® Celeron® M723, 1.2GHz, 800MHz FSB, 1MB cache, 10W

#### Memory

- System RAM
  - 1 GB, 2GB or 4GB

Please note that some of these options may only be available for large volumes. Please ask our sales staff for more information.

## Ordering Information

<b>Standard XM2 Models</b>	<b>15XM02-00</b>	Intel® Core™ 2 Duo SP9300 2.26 GHz, 2GB DDR3, 0..+85°C Tcase
	<b>15XM02-01</b>	Intel® Celeron® M M722 1.2GHz, 2GB DDR3, 0..+85°C Tcase
<b>Related Hardware</b>	<b>08AE12-00</b>	ESMexpress® module to COM Express™ carrier adapter, 0..+60°C
	<b>08XC01-00</b>	Evaluation and development board for all ESMexpress® modules (coming with top cover and frame), 0..+60°C, incl. faceplate, 4 GB USB Flash Disk and USB cable type A to A
	<b>08XC02-00</b>	Carrier board for ESMexpress® modules (Intel®), 4 GB USB Flash Disk, LVDS and DVI on board, 2 Fast Ethernet on M12, 1 SA-Adapter™ slot, 2 USB 2.0, PCI Express® Mini Card slot, 24V PSU (9..36VDC), -40..+85°C with qualified components
<b>Miscellaneous Accessories</b>	<b>0712-0019</b>	Standard ATX PSU, 350 W, 0..+40°C
<b>Software: Linux</b>	This product is designed to work under Linux. See below for potentially available separate software packages from MEN.	
	<b>13XM01-06</b>	MDIS5™ low-level driver sources (MEN) for XM1, XM1L, MM1, MM2, XM2, F11S, F19P, F21P, F22P, G20, G22, SC21, SC27 and DC2 board controller
<b>Software: Windows®</b>	This product is designed to work under Windows®. See below for potentially available separate software packages from MEN.	
	<b>10F014-78</b>	Windows® XP Embedded BSP (MEN) for F11S, F14, F15, F17, F18, F19P, F21P, G20, XM1, XM1L, XM2, MM1, MM2, SC21, SC24, DC1, DC2, RC1, BC50I, BC50M and BL50W
	<b>10Y000-78</b>	Windows® Embedded Standard 7 BSP for F11S, F19P, F21P, F22P, F75P, G20, G22, XM1L, XM2, MM1, MM2, SC21, SC24, SC27, BC50M, BC50I, BL50W, BL50S, DC13, F206, F210, F215, F216, G215, P506, P507 and P511
	<b>13T003-70</b>	Windows® chipset driver (Intel®) for F14, F15, F17, F18, F18E, F19P, F21P, F22P, G20, G22, XM2, D9, D6, D7, D601, A19 and A20
	<b>13T005-70</b>	Windows® USB2UART driver (FTDI) for F14, F15, F17, F18, F19P, F21P, F22P, D9, A19, A20, XM2 and XM50 / XM51 / F50P / F50C hosts
	<b>13T010-70</b>	Windows® 32-bit network driver (Intel®) for XM1, XM1L, XM2, MM2, F11S, F18, F18E, F19P, F21P, F22P, G20, G22, GM1, GM2, G211, G211F, SC24, BC50I, BC50M and BL50W
	<b>13T019-70</b>	Windows® graphics driver (Intel®) for XM2 and F19P
	<b>13T020-70</b>	Windows® 64-bit network driver (Intel®) for F18, F18E, F19P, F21P, F22P, G20, G22, GM1, GM2, G211, G211F, XM2, SC24, BC50I, BC50M and BL50W
	<b>13XM02-77</b>	Windows® Installset (MEN) for XM2 and F19P (Includes all free drivers developed by MEN for the supported hardware.)
<b>Software: VxWorks®</b>	This product is designed to work under VxWorks®. For details regarding supported/unsupported board functions please refer to the corresponding software data sheets.	
	<b>13XM01-06</b>	MDIS5™ low-level driver sources (MEN) for XM1, XM1L, MM1, MM2, XM2, F11S, F19P, F21P, F22P, G20, G22, SC21, SC27 and DC2 board controller

## Ordering Information

<b>Software: QNX®</b>	<p>This product is designed to work under QNX®. For details regarding supported/unsupported board functions please refer to the corresponding software data sheets.</p> <table border="1"> <tr> <td><b>10F014-40</b></td> <td>QNX® 6.3.0 installation support files (QNX® and MEN) for F14, F15, F17, F18, F19P, XM1, XM2 and MM1</td> </tr> <tr> <td><b>10F019P40</b></td> <td>QNX® 6.4.0 BSP (QNX® and MEN) for F19P and XM2</td> </tr> <tr> <td><b>13XM01-06</b></td> <td>MDIS5™ low-level driver sources (MEN) for XM1, XM1L, MM1, MM2, XM2, F11S, F19P, F21P, F22P, G20, G22, SC21, SC27 and DC2 board controller</td> </tr> </table>	<b>10F014-40</b>	QNX® 6.3.0 installation support files (QNX® and MEN) for F14, F15, F17, F18, F19P, XM1, XM2 and MM1	<b>10F019P40</b>	QNX® 6.4.0 BSP (QNX® and MEN) for F19P and XM2	<b>13XM01-06</b>	MDIS5™ low-level driver sources (MEN) for XM1, XM1L, MM1, MM2, XM2, F11S, F19P, F21P, F22P, G20, G22, SC21, SC27 and DC2 board controller
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### Software: Miscellaneous

Intel® software development products such as analyzers, compilers, threading tools etc. can be downloaded under [www.intel.com/cd/software/products/asm-na/eng/index.htm](http://www.intel.com/cd/software/products/asm-na/eng/index.htm). IA-32 Intel® Architecture Software Developer's Manuals are available under [www.intel.com/products/processor/manuals/index.htm](http://www.intel.com/products/processor/manuals/index.htm).

For operating systems not mentioned here [contact MEN sales](#).

<b>Documentation</b>	<p>Compare Chart ESMexpress® Embedded System Modules » <a href="#">Download</a></p> <p>You can find general literature on MEN computer-on-modules, including presentations about ESMexpress®, ESMini™ and their cooling concept, in our <a href="#">Download Library</a>.</p> <table border="1"> <tr> <td><b>20APPN004</b></td> <td>Application Note: How to make a USB stick bootable</td> </tr> <tr> <td><b>20XM02-ER</b></td> <td>XM2 Errata</td> </tr> <tr> <td><b>20XM02-00</b></td> <td>XM2 User Manual</td> </tr> <tr> <td><b>21APPN015</b></td> <td>Application Note: Using Real-Time Operating Systems on MEN CPUs with InsydeH2O™ UEFI BIOS</td> </tr> <tr> <td><b>21APPN016</b></td> <td>Application Note: Accessing SMBus under Linux Kernel 3.2 on MEN Intel® Boards</td> </tr> </table>	<b>20APPN004</b>	Application Note: How to make a USB stick bootable	<b>20XM02-ER</b>	XM2 Errata	<b>20XM02-00</b>	XM2 User Manual	<b>21APPN015</b>	Application Note: Using Real-Time Operating Systems on MEN CPUs with InsydeH2O™ UEFI BIOS	<b>21APPN016</b>	Application Note: Accessing SMBus under Linux Kernel 3.2 on MEN Intel® Boards
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